

Correlating Fluorescence Microscopy with Electron Microscopy

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The use of fluorescent probes is becoming more and more common in cell biology. It would be useful if we were able to correlate a fluorescent structure with an electron microscopic image. The ability to definitively identify a fluorescent organelle would be very valuable. Recently, Ying Ren, Michael Kruhlak, and David Bazett-Jones devised a clever technique to correlate a structure visualized in the light microscope, even a fluorescing cell, with transmission electron microscopy (TEM).²

Two keys to the technique of Ren *et al.* are the use of grids (as used in the TEM) with widely spaced grid bars and the use of Quetol as the embedding resin. The grids allow for cells to be identified between the grid bars, and in turn the bars are used to keep the cell of interest in register throughout the processing for TEM. Quetol resin was used for embedding because of its low autofluorescence and sectioning properties. The resin also becomes soft and can be cut and easily peeled from glass coverslips when heated to 70°C.

For demonstrating the technique, Ren *et al.* grew neuroblastoma cells on coverslips. After fixing and permeabilizing the cells, they were exposed to monoclonal antibodies for promyelocytic leukemia (PML) protein. The specimen was then treated with a second antibody that was tagged with a fluorophore. The coverslips were mounted on slides using a glycerol-based mounting media and the fluorescing cells (or cell) of interest were identified at high magnification then imaged at low magnification with a light microscope (LM), with or without fluorescence. After an image record of the cells had been made, a 50 mesh copper grid was positioned over the cells of interest and attached to the coverslip with transparent tape. The slide was then returned to the LM and the exact location of the cells with respect to the 16 grid openings was noted. The coverslip was separated from

the slide, placed in a 40-mm petri dish, washed with phosphate buffered saline to remove the mounting media and processed for TEM.

For the final embedding step the coverslip (cells up) was covered with a thin layer (0.5-2 mm) of Quetol 651 mix and polymerized. Once polymerized, a second grid was glued to the resin in register to the grid on the coverslip. The petri dish was placed on a hot plate at 70°C. After a few minutes the resin softened and was cut within the perimeter of the coverslip with a scalpel. The cut resin was then carefully peeled off the coverslip. A third grid was placed on the cell side of the Quetol block in perfect register with the second grid. The region of interest was marked with a sharp scalpel and the grid opening was also marked with a felt-tip pen. A large selected area was cut with a razor blade and glued onto a blank bullet and mounted onto an ultramicrotome for sectioning.

When the block surface was lightly wiped with 95% ethanol, the cells could be seen and compared with images captured earlier with the fluorescence microscope. The exact cell(s) was identified, the block further trimmed, and thin sectioned. The grid with the sections was placed on a glass slide, covered with a coverslip, and imaged with a fluorescence microscope at low (to determine the position of the cell of interest with respect to the grid bars) and high (to obtain the highest resolution of fluorescence labeling present) magnification. The grid was then transferred to the electron microscope where conventional TEM and electron spectroscopic imaging were employed. Correlative fluorescence and ultrastructural images from the region(s) of interest were compared and contrasted. With this method detail at the suborganelle level was obtained. We followed the methods of Ren *et al.* in our lab, and it worked on the first try.

It will be exciting to see the interesting uses for this advance in correlative microscopy! ■

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² Ren, Y., M.J. Kruhlak, and D.P. Bazett-Jones, Same serial section correlative light and energy-filtered transmission electron microscopy, *J. Histochem. Cytochem.* 51:605-612, 2003.

INDEX OF ARTICLES

Correlating Fluorescence Microscopy with Electron Microscopy	3
Stephen W. Carmichael and Jon Charlesworth, Mayo Clinic	
Electron Microscopy Enters a New Era Using Aberration Correction	8
P.E. Batson, IBM Research	
Microscopy and Imaging of Foods— The Whys and Hows	14
Paula Allan-Wojtas, Agriculture and Agri-Food Canada	
Image Stitching Using Photoshop	22
Jerry Sedgewick, University of Minnesota	
A Few Thoughts About Image File Storage	26
Michael Bode, Soft Imaging System Corp.	
Behavior of Particle Size Distributions, Means and BET Values in Ideal and Non-Ideal Morphology Systems in a TEM	30
Paul Beaugerard, Chemist and Electron Microscopist	
The Moving Finger Writes: Carbon Nanotubes as AFM Probe Tips	34
Katerina Moloni, nPoint, Inc.	
Confocal Microscopy System Performance: Axial Resolution	38
Robert M. Zucker, U.S. Environmental Protection Agency	
Enhanced Sample Preparation of Cu Low-k Semiconductors via Mechanical Polishing and Ion Beam Etching	41
Shane Roberts, Daniel Flatoff, South Bay Technology, Inc.	
The Year That Was! Microscopy in Southern Africa	44
Luc Harmsen, Anaspec, South Africa	

Comments on Cryo High Resolution Scanning Electron Microscopy	45
Robert P. Apkarian, IM&MF/Emory University	
Propylene Oxide: To Use or Not to Use in Biological Tissue Processing	45
Jose A. Mascorro, Tulane University	
Is Low Accelerating Voltage Always the Best for Semiconductor Inspection and Metrology?	46
M. T. Postek and A. E. Vladár, National Institute of Standards and Technology	
Industry News	48
NetNotes	50
Index of Advertisers	54

ABOUT THE COVER

Aberration Corrected, High Resolution Image P.E. Batson, IBM Research

Annular Dark Field STEM image of a Au island on a carbon resolution test specimen using a 1 Angstrom probe. The data have been Fourier filtered to reduce noise. Single Au atoms, and monolayer "rafts" of Au atoms are visible nearby. The large Au island is about 50 Angstroms in diameter.

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- ✓ **Asia-Pacific Congress on Electron Microscopy**
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keih@kanazawa-med.ac.jp
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www.ifschc.org/index2004.html/
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rapkari@emory.edu
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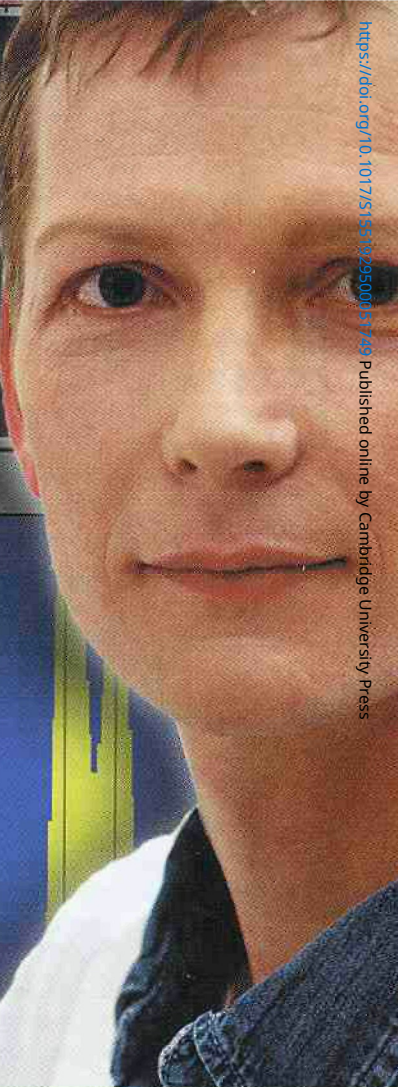
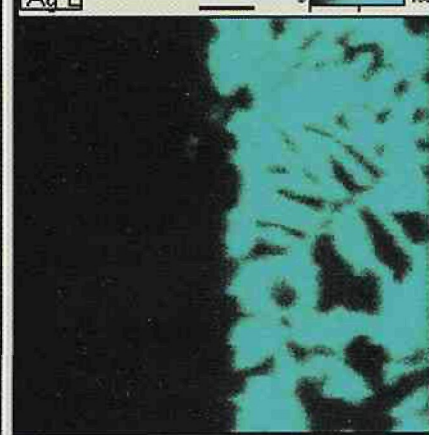
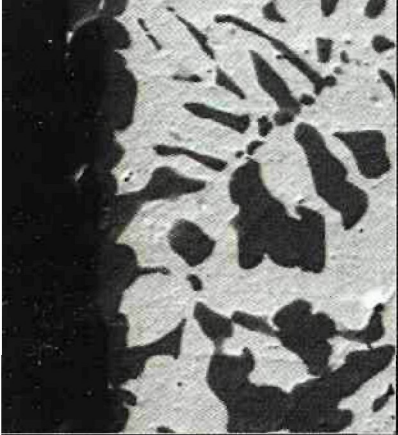
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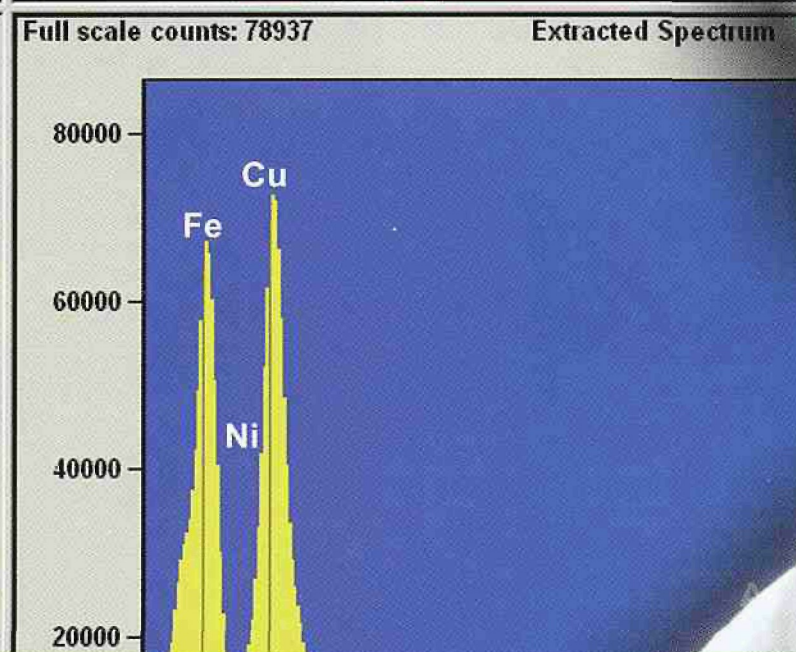
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